



OSG07N65x_Datasheet



Enhancement Mode N-Channel Power MOSFET

Features

- ◆ Low $R_{DS(on)}$ & FOM
- ◆ Extremely low switching loss
- ◆ Excellent stability and uniformity
- ◆ Easy to drive

Applications

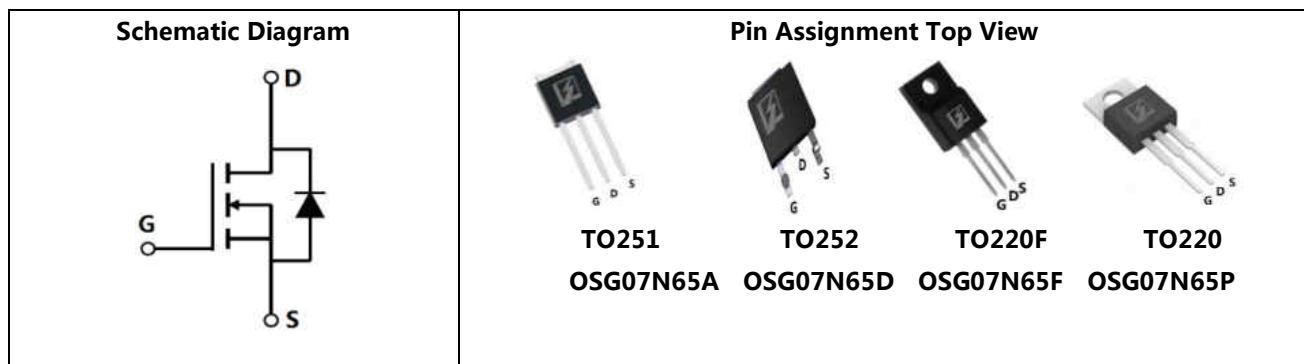
- ◆ Lighting
- ◆ Hard switching PWM
- ◆ Server power supply
- ◆ Charger

■ General Description

OSG07N65x use advanced GreenMOS™ technology to provide low $R_{DS(ON)}$, low gate charge, fast switching and excellent avalanche characteristics. This device is suitable for active power factor correction and switching mode power supply applications.

| | |
|--------------------------------------|--------------|
| ◆ V_{DS} , min@ T_{jmax} | 700 V |
| ◆ I_D , pulse | 13.5 A |
| ◆ $R_{DS(ON)}$, max @ $V_{GS}=10$ V | 1.0 Ω |
| ◆ Q_g | 7.0 nC |

■ Schematic and Package Information



■ Absolute Maximum Ratings at $T_j=25^\circ\text{C}$ unless otherwise noted

| Parameter | Symbol | Value | Unit |
|--|-------------------|------------|------|
| Drain source voltage | V_{DS} | 650 | V |
| Gate source voltage | V_{GS} | ± 30 | V |
| Continuous drain current ¹⁾ | I_D | 4.5 | A |
| Continuous drain current ¹⁾ $T_j=100^\circ\text{C}$ | | 2.8 | |
| Pulsed drain current ²⁾ | I_D , pulse | 13.5 | A |
| Power dissipation ³⁾ for TO251, TO252, TO220 | P_D | 28.4 | W |
| Power dissipation ³⁾ for TO220F | | 24 | |
| Single pulsed avalanche energy ⁵⁾ | E_{AS} | 100 | mJ |
| MOSFET dv/dt ruggedness, $V_{DS}=0\ldots 480$ V | dv/dt | 50 | V/ns |
| Reverse diode dv/dt, $V_{DS}=0\ldots 480$ V, $I_{SD} \leq I_D$ | dv/dt | 15 | V/ns |
| Operation and storage temperature | T_{stg} , T_j | -55 to 150 | °C |

■ Thermal Characteristics

| Parameter | Symbol | Value | | Unit |
|--|------------------|-------------------|--------|------|
| | | TO251/TO252/TO220 | TO220F | |
| Thermal resistance, junction-case | R _{θJC} | 4.4 | 5.2 | °C/W |
| Thermal resistance, junction-ambient ⁴⁾ | R _{θJA} | 62 | 62.5 | °C/W |

■ Electrical Characteristics at T_j=25 °C unless otherwise specified

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test condition |
|----------------------------------|---------------------|------|------|------|------|--|
| Drain-source breakdown voltage | BV _{DSS} | 650 | | | V | V _{GS} =0 V, I _D =250 μA |
| | | 700 | 770 | | | V _{GS} =0 V, I _D =250 μA T _j =150 °C |
| Gate threshold voltage | V _{GS(th)} | 2.0 | | 4.0 | V | V _{DS} =V _{GS} , I _D =250 μA |
| Drain-source on-state resistance | R _{DS(ON)} | | 0.9 | 1.0 | Ω | V _{GS} =10 V, I _D =2 A |
| | | | 2.16 | | | V _{GS} =10 V, I _D =2 A, T _j =150 °C |
| Gate-source leakage current | I _{GSS} | | | 100 | nA | V _{GS} =30 V |
| | | | | -100 | | V _{GS} =-30 V |
| Drain-source leakage current | I _{DSS} | | | 1 | μA | V _{DS} =650 V, V _{GS} =0 V |

■ Dynamic Characteristics

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test condition |
|------------------------------|---------------------|------|-------|------|------|---|
| Input capacitance | C _{iss} | | 251.2 | | pF | V _{GS} =0 V, V _{DS} =50 V, f=1 MHz |
| Output capacitance | C _{oss} | | 29.7 | | pF | |
| Reverse transfer capacitance | C _{rss} | | 1.3 | | pF | |
| Turn-on delay time | t _{d(on)} | | 31.3 | | ns | V _{GS} =10 V, V _{DS} =400 V, R _G =25 Ω, I _D =3 A |
| Rise time | t _r | | 17.4 | | ns | |
| Turn-off delay time | t _{d(off)} | | 67.7 | | ns | |
| Fall time | t _f | | 27.5 | | ns | |

■ Gate Charge Characteristics

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test condition |
|----------------------|---------------|------|------|------|------|---|
| Total gate charge | Q_g | | 7.0 | | nC | $I_D=3\text{ A}$, $V_{DS}=400\text{ V}$, $V_{GS}=10\text{ V}$ |
| Gate-source charge | Q_{gs} | | 1.9 | | nC | |
| Gate-drain charge | Q_{gd} | | 3.2 | | nC | |
| Gate plateau voltage | $V_{plateau}$ | | 5.6 | | V | |

■ Body Diode Characteristics

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test condition |
|-------------------------------|-----------|------|-------|------|---------------|---|
| Diode forward current | I_S | | | 4.5 | A | $V_{GS} < V_{th}$ |
| Pulsed source current | I_{SP} | | | 13.5 | | |
| Diode forward voltage | V_{SD} | | | 1.3 | V | $I_S=4.5\text{ A}$, $V_{GS}=0\text{ V}$ |
| Reverse recovery time | t_{rr} | | 204.8 | | ns | $V_R=400\text{ V}$, $I_S=3\text{ A}$, $di/dt=100\text{ A}/\mu\text{s}$ |
| Reverse recovery charge | Q_{rr} | | 1.1 | | μC | |
| Peak reverse recovery current | I_{rrm} | | 12.1 | | A | |

■ Note

- 1) Calculated continuous current based on maximum allowable junction temperature.
- 2) Repetitive rating; pulse width limited by max. junction temperature.
- 3) P_d is based on max. junction temperature, using junction-case thermal resistance.
- 4) The value of $R_{\theta JA}$ is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with $T_a=25\text{ }^{\circ}\text{C}$.
- 5) $V_{DD}=100\text{ V}$, $R_G=25\text{ }\Omega$, $L=20\text{ mH}$, starting $T_j=25\text{ }^{\circ}\text{C}$.

■ Electrical Characteristics Diagrams

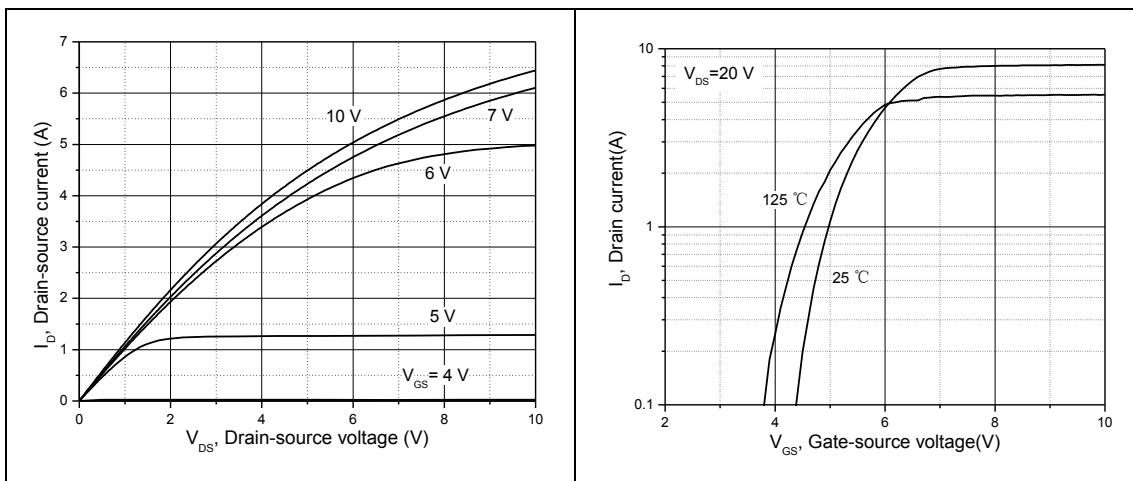


Figure 1, Typ. output characteristics

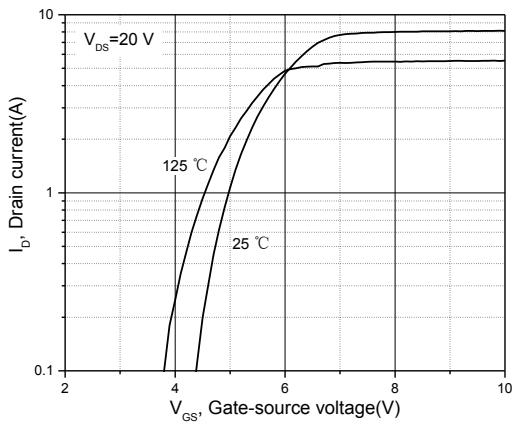


Figure 2, Typ. transfer characteristics

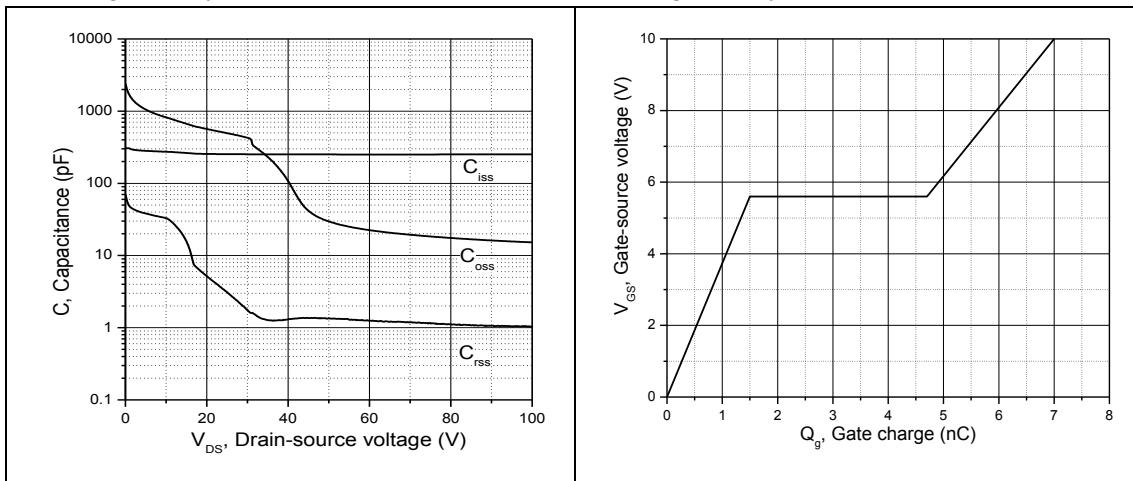


Figure 3, Typ. capacitances

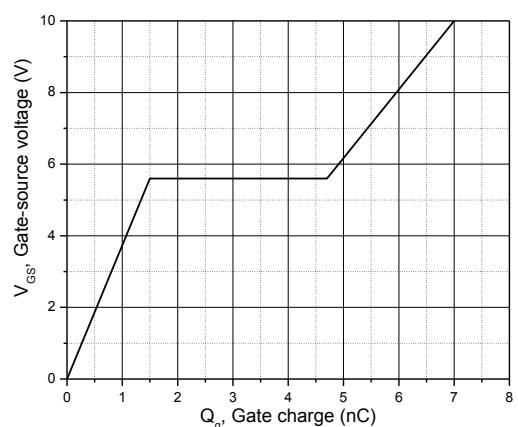


Figure 4, Typ. gate charge

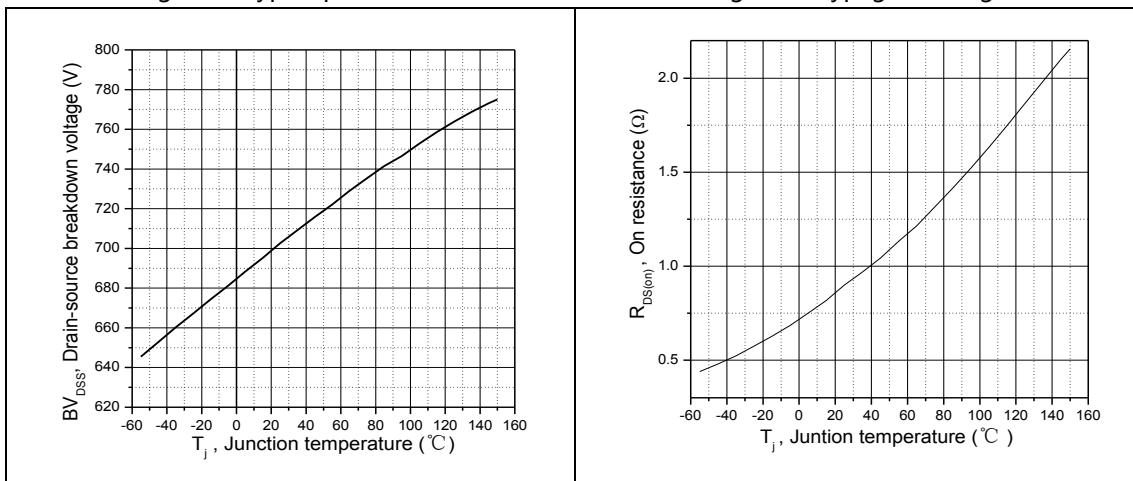


Figure 5, Drain-source breakdown voltage

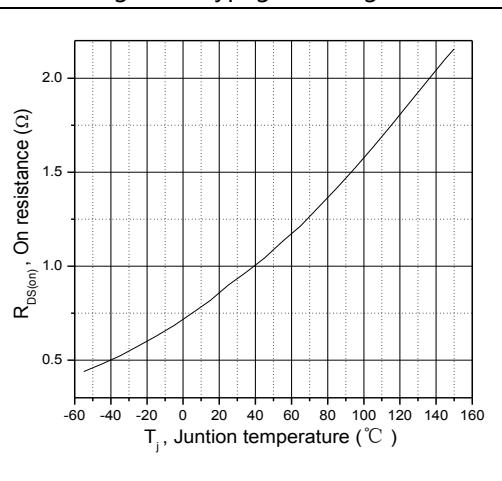


Figure 6, Drain-source on-state resistance

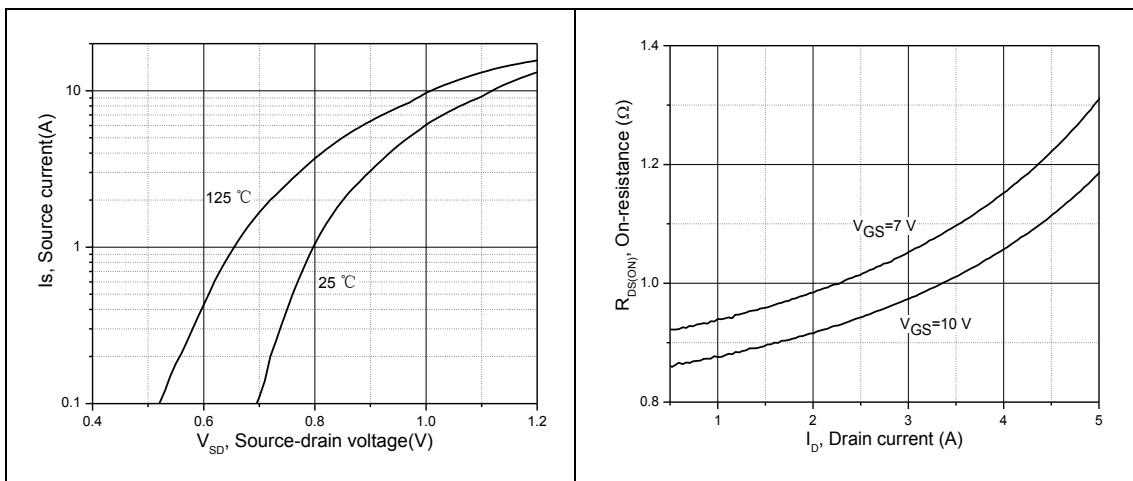


Figure 7, Forward characteristic of body diode

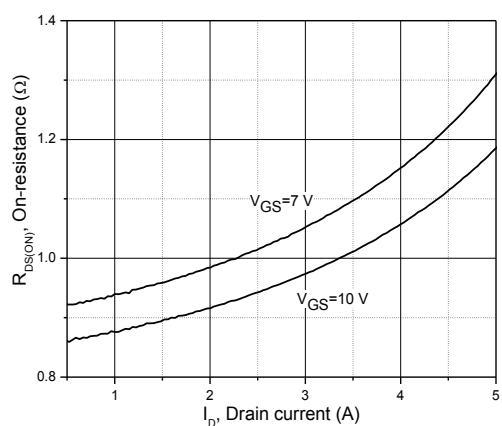


Figure 8, Drain-source on-state resistance

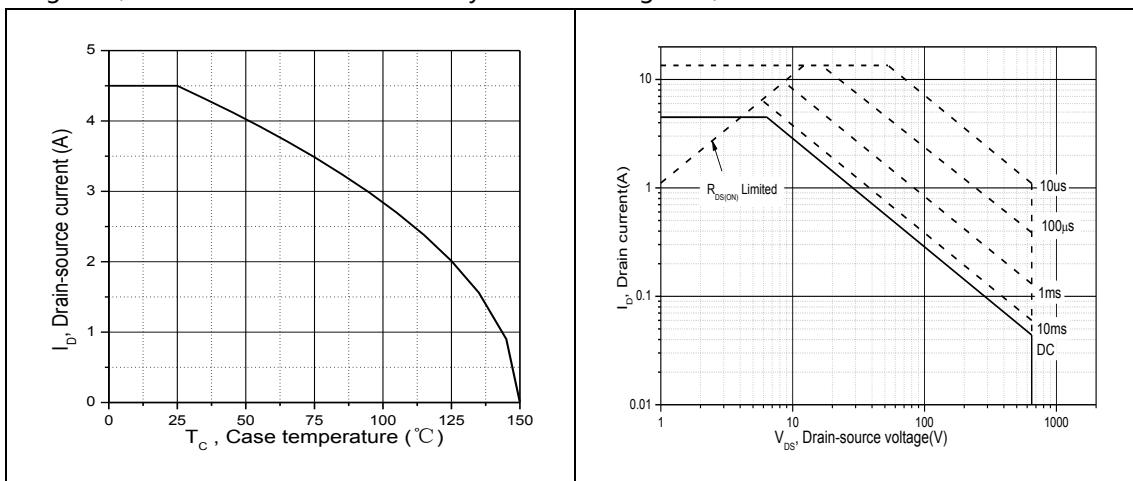


Figure 9, Drain current

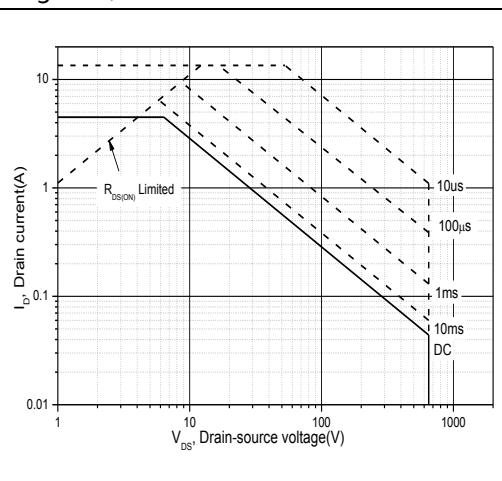


Figure 10, Safe operation area for
TO251/TO252/TO220 $T_C = 25^\circ\text{C}$

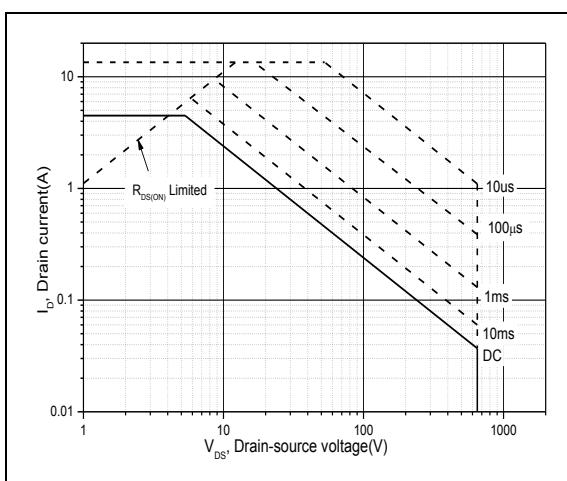


Figure 11, Safe operation area for TO220F
 $T_C = 25^\circ\text{C}$

■ Test circuits and waveforms

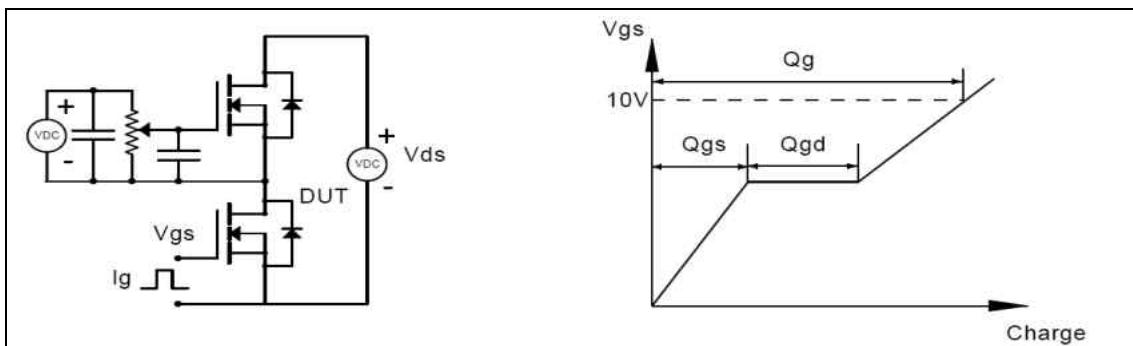


Figure 1, Gate charge test circuit & waveform

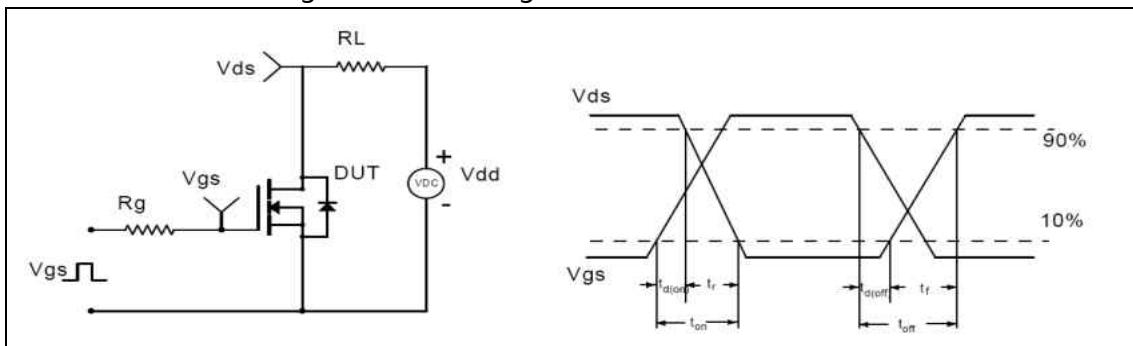


Figure 2, Switching time test circuit & waveforms

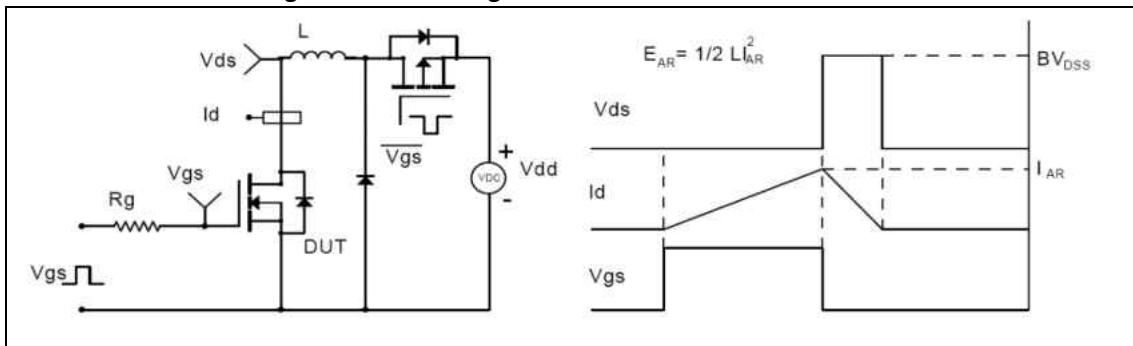


Figure 3, Unclamped inductive switching (UIS) test circuit & waveforms

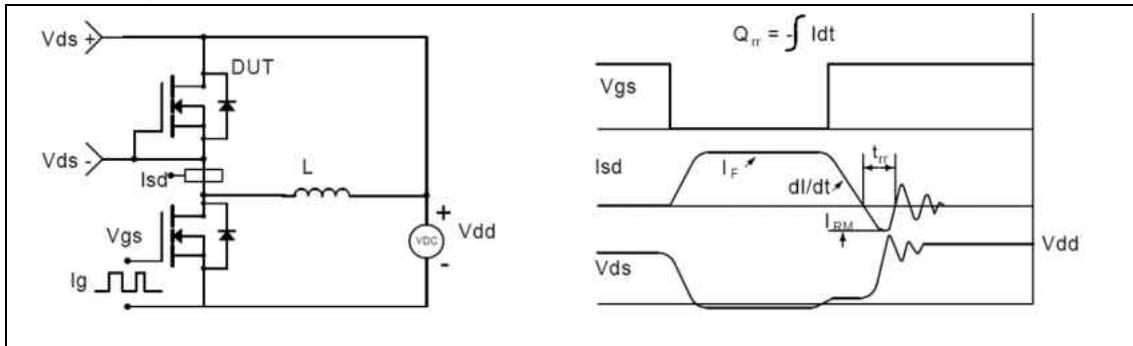
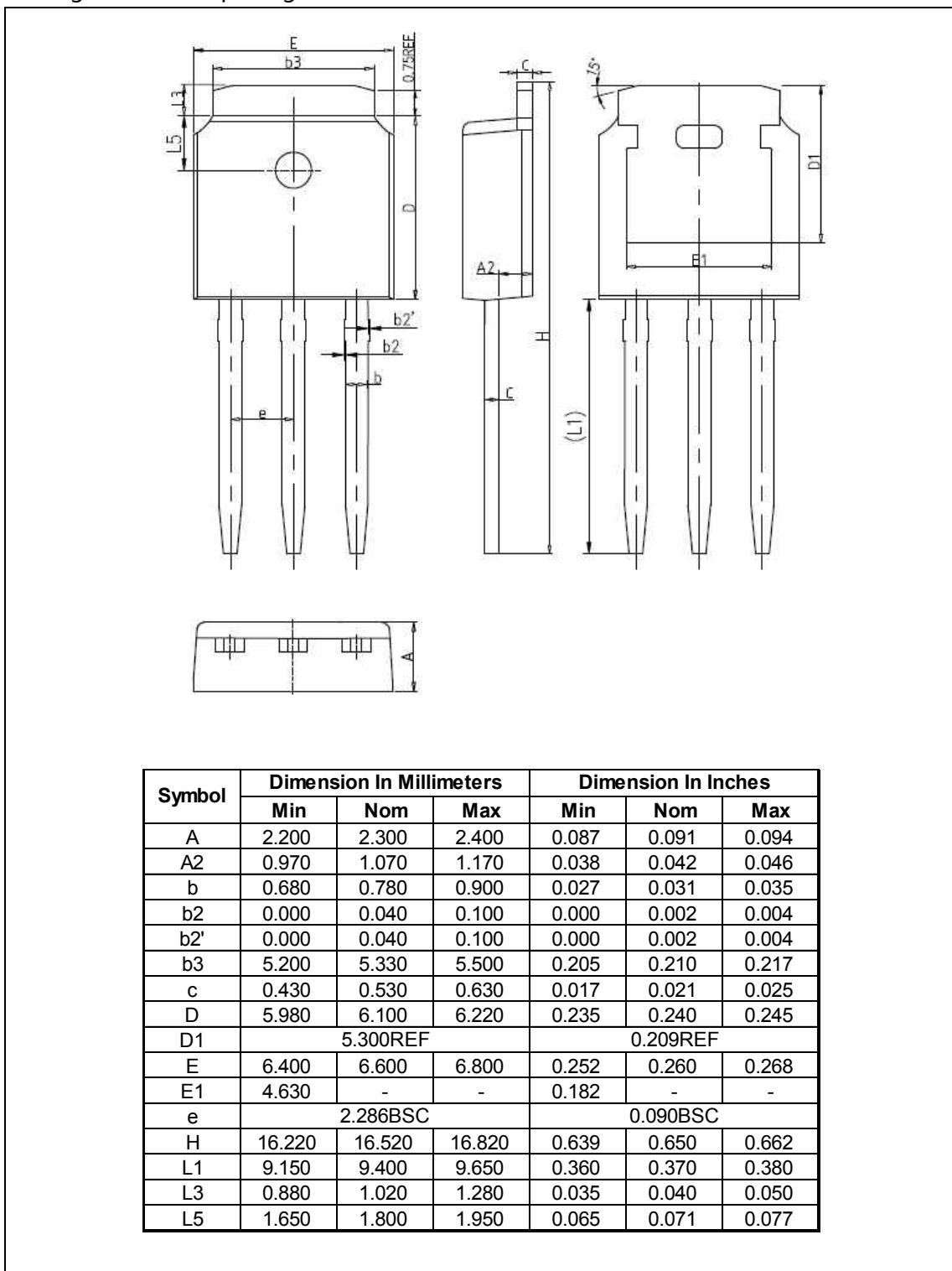


Figure 4, Diode reverse recovery test circuit & waveforms

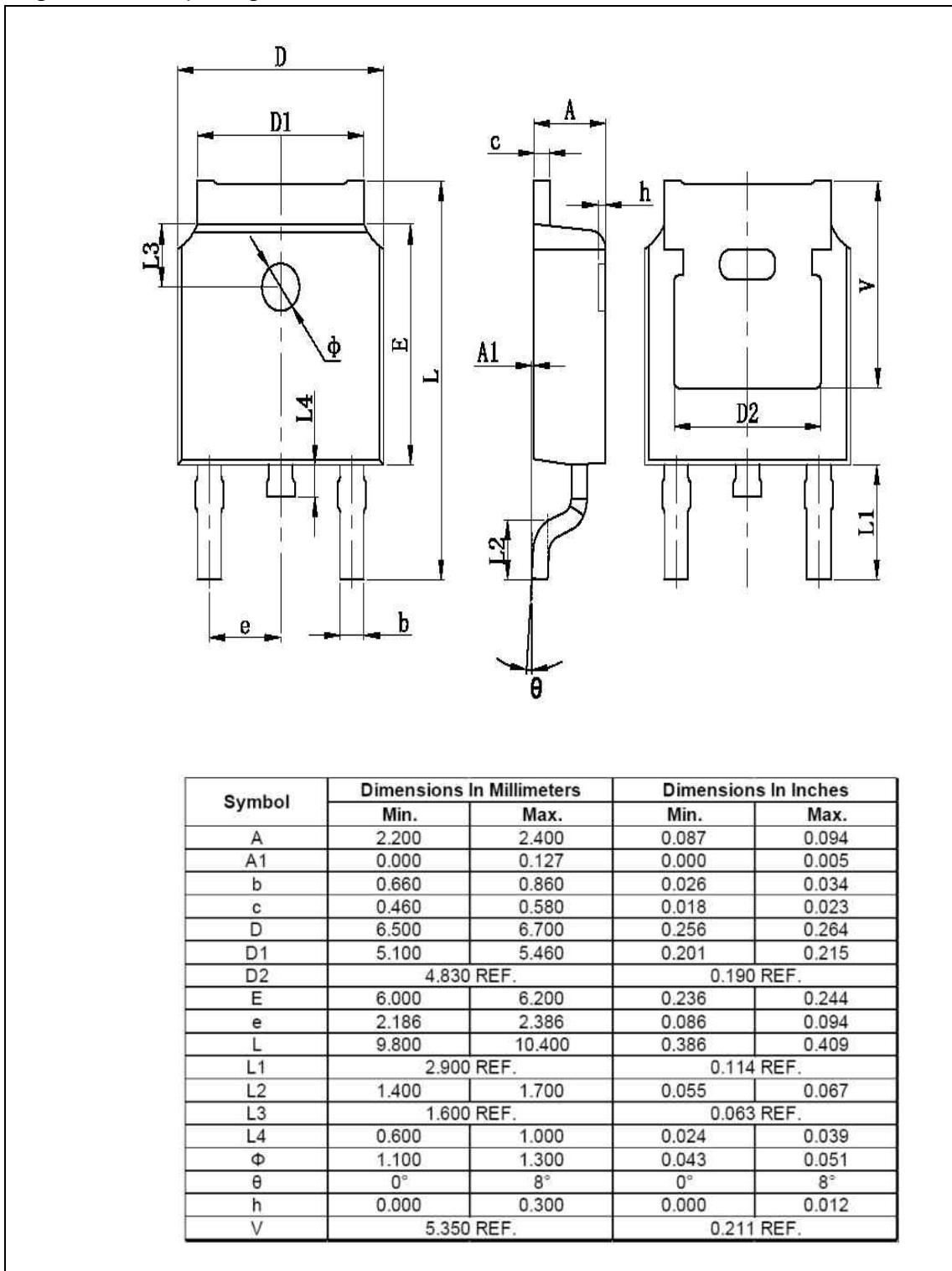
■ Package Information

Figure1, TO251 package outline dimension



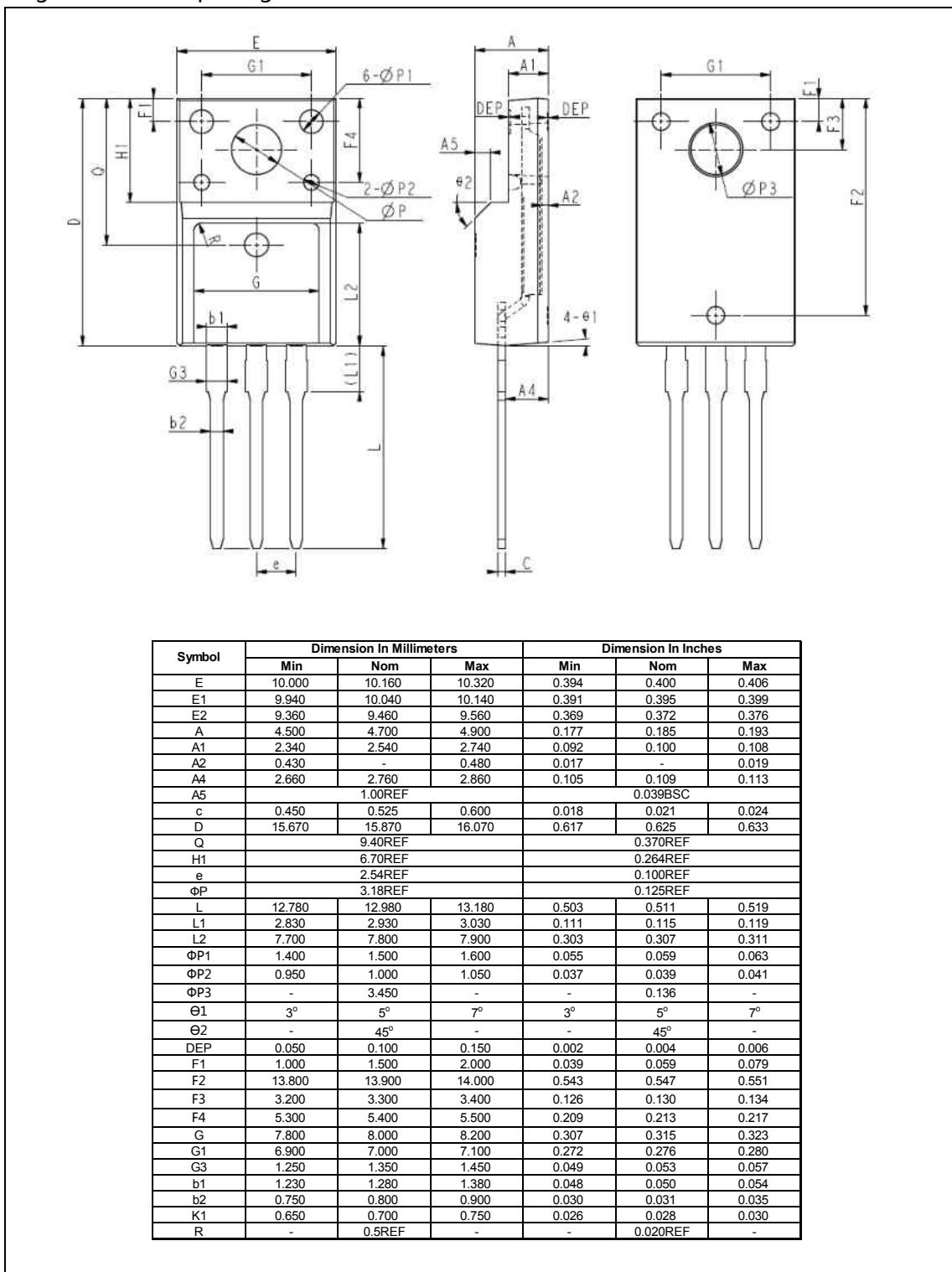
■ Package Information

Figure2, TO252 package outline dimension



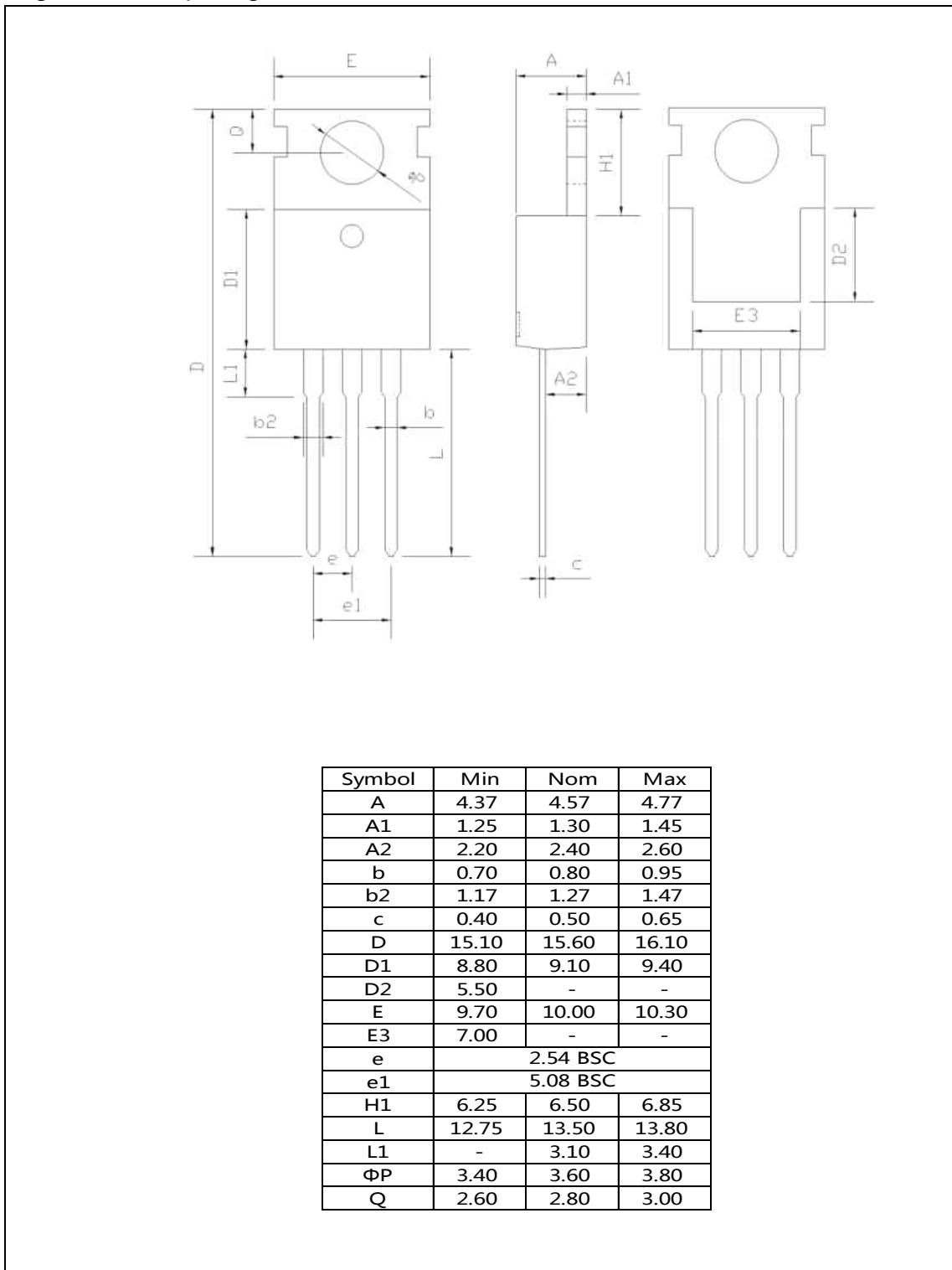
■ Package Information

Figure3, TO220F package outline dimension



■ Package Information

Figure4, TO220 package outline dimension



■ Ordering Information

| Package | Units/Tube | Tubes/Inner Box | Units/Inner Box | Inner Box/Carton Box | Units/Carton Box |
|---------------|------------|-----------------|-----------------|----------------------|------------------|
| TO251 | 75 | 66 | 4950 | 6 | 29700 |
| TO252 Option1 | 75 | 66 | 4950 | 6 | 29700 |
| TO220F | 50 | 20 | 1000 | 6 | 6000 |
| TO220 | 50 | 20 | 1000 | 6 | 6000 |

| Package | Units/Tape | Tapes/Inner Box | Units/Inner Box | Inner Box/Carton Box | Units/Carton Box |
|---------------|------------|-----------------|-----------------|----------------------|------------------|
| TO252 Option2 | 2500 | 2 | 5000 | 5 | 25000 |

■ Product Information

| Product | Package | Pb Free | RoHS | Halogen Free |
|------------|---------|---------|------|--------------|
| OSG07N65A | TO251 | yes | yes | no |
| OSG07N65AF | TO251 | yes | yes | yes |
| OSG07N65D | TO252 | yes | yes | no |
| OSG07N65DF | TO252 | yes | yes | yes |
| OSG07N65F | TO220F | yes | yes | no |
| OSG07N65FF | TO220F | yes | yes | yes |
| OSG07N65P | TO220 | yes | yes | no |
| OSG07N65PF | TO220 | yes | yes | yes |